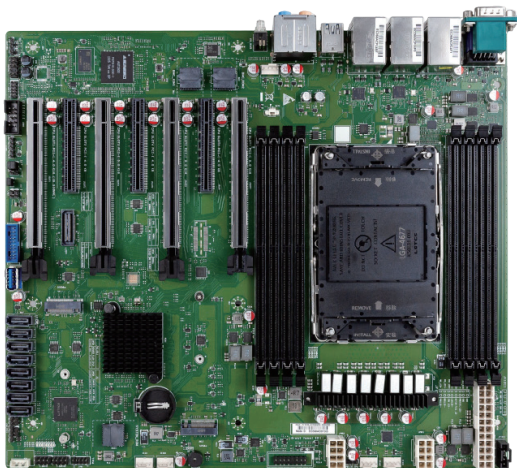




FEATURES

- Supports one high-performance Scalable Sapphire Rapids W2400(64L) or W3400 (112L) processors
- 8 DDR5 RDIMM memory slots, up to 2TB ECC RDIMM
- 8 SATA3(6Gb/s) interfaces and supports RAID 0, 1, 5, and 10, providing multiple storage solutions for enterprise applications
- 3 RJ45 network ports, two 2.5GbE ports, and one is an IPMI management interface
- 3 PCIe 5.0 x8 and 4 PCIe 5.0 x16 slots for flexiable

SPECIFICATIONS

System

CPU	1 x Socket E LGA 4677, Intel Xeon Scalable Sapphire Rapids Workstation Series
Chipset	Intel W790 Chipset
Memory	Slots, 8 slots (8-channel); 64L only supports DIMMA1/DIMMB1/DIMME1/DIMMF1, Supports 4800/4400MHz ECC DDR5 RDIMM Capacity, W2400 Processor: 64L up to 1TB 3DS RDIMM, W3400 Processor: 112L up to 2TB 3DS RDIMM Size, 16G, 32G, 64G, 128G, 256G
Storage	8 x SATA3 6Gb/s ports, supports RAID 0/1/5/10, 2 x M.2 2280 (PCIe 4.0 x4)
Networking	2 x RJ45, 10/100/1000/2500Mbps, 1 x RJ45, 10/100/1000Mbps, IPMI Management
Display	1 x VGA, chip ASPEED AST2500 BMC
Expansion	3 x PCIe 5.0 x16 slots(x16 signal), 1 x PCIe 5.0 x16(x8 signal), 64L supports slot1/3/5/7, 3 x PCIe 5.0 x8(x8 slot)
Onboard I/O	1 x Front COM header, 1 x TPM header, 5 x 4-pin Fan headers, 1 x Chassis Intrusion header, 1 x Front Audio header, 1 x 24-pin ATX + 8-pin + 8-pin Power connectors, 1 x USB 3.0 pin header (up to 2 devices), 1 x USB 2.0 pin header (up to 2 devices), 2 x M.2 (NGFF 2280/2242, supports NVMe SSD), 1 x SMBus, 1 x USB 3.0 Type A
Rear I/O	1 x VGA, 1 x COM, 1 x IPMI, 2 x USB 2.0, 5 x USB 3.0, 2 x RJ-45 LAN, 1 x Type-C, 1 x 8-ch Audio, 1 x UID switch(LED)

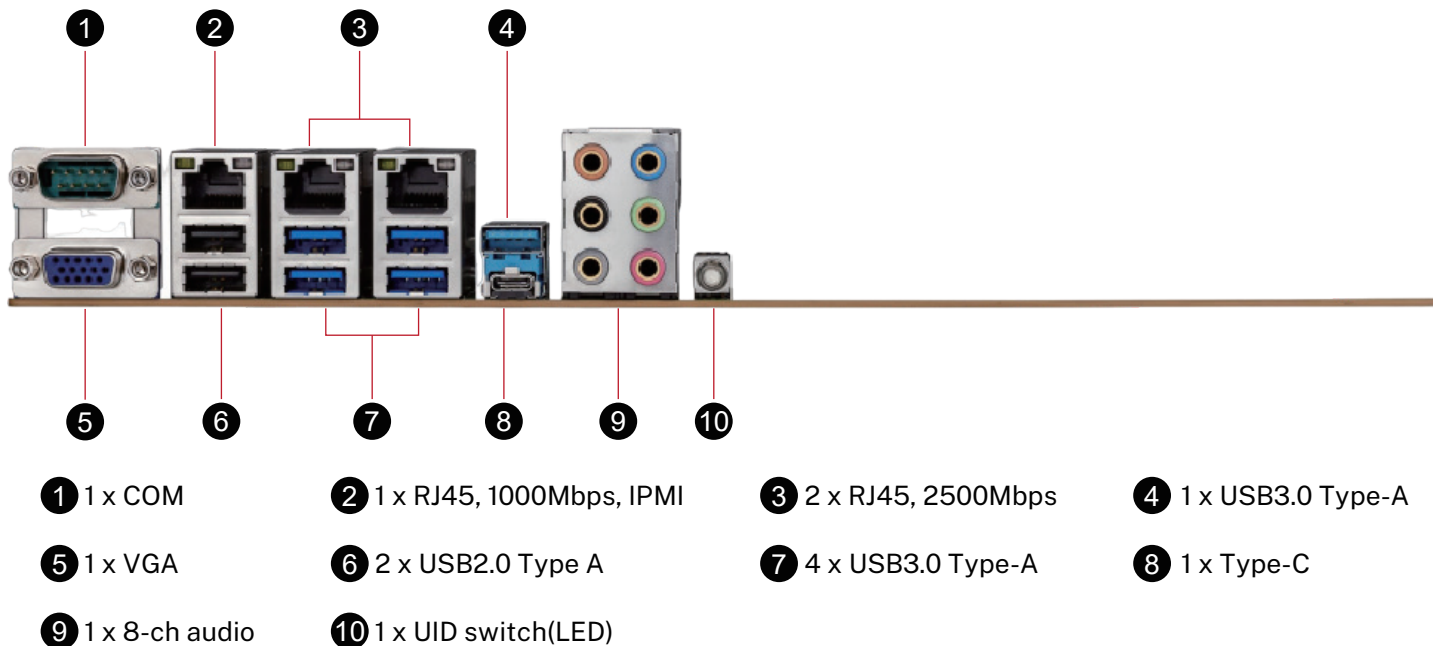
Product Dimensions

Dimensions	304.93 x 265.05 mm (12.0 x 10.4 in)
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Product Dimensions

Operating Temperature	0~35℃ (32~95°F)
Storage Temperature	-40~70℃ (-40~158°F)
Operating Humidity	8% ~ 90% (Non-condensing)
Storage Humidity	5% ~ 95% (Non-condensing)

I/O LAYOUT



PRODUCT DIMENSIONS

unit: mm

